SPST Reflective AlGaAs PIN Diode Switch

Features

- Ultra Broad Bandwidth: 50 MHz to 50 GHz
- Functional Bandwidth: 50 MHz to 70 GHz
- 0.3 dB Insertion Loss
- 46 dB Isolation @ 50 GHz
- Low Current consumption
 - -5 V for Low Loss State
 - +10 mA for Isolation State
- Unique AlGaAs Hetero-Junction Anode Technology
- Silicon Nitride Passivation
- Polymer Scratch Protection
- RoHS Compliant* & 260°C Reflow Compatible

Description

The MA4AGSW1 is an aluminum-gallium-arsenide, single pole, single throw (SPST), PIN diode switch. The switch features enhanced AlGaAs anodes which are formed using a patented hetero-junction technology. This technology produces a switch with less loss than conventional GaAs processes. As much as a 0.3 dB reduction in insertion loss can be realized at 50 GHz. These devices are fabricated on an OMCVD epitaxial wafer using a process designed for high device uniformity and extremely low parasitics. The diodes themselves exhibit low series resistance, low capacitance, and fast switching speed. They are fully passivated with silicon nitride and have an additional polymer layer for scratch protection. The protective coating prevents damage to the diode junction and anode air-bridges during handling and assembly. Off chip bias circuitry is required.

Applications

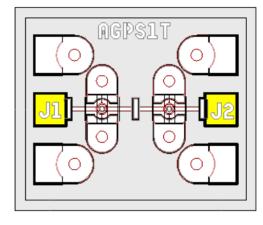
1

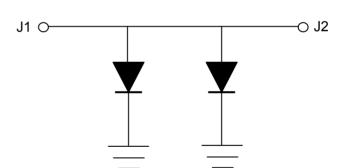
The high electron mobility of AlGaAs and the low capacitance of the PIN diodes makes this switch ideal for fast switching, high frequency, multi-throw switch designs. These AlGaAs PIN switches are use in switching arrays for radar systems, radiometers, test equipment and other multi-assembly components.

* Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

Visit <u>www.macom.com</u> for additional data sheets and product information.





Yellow areas indicate bond pads

Ordering Information

Part Number	Package	
MA4AGSW1	Waffle Pack	

Rev. V6



МАСОМ

SPST Reflective AlGaAs PIN Diode Switch

Rev. V6

MACOM

Parameter **Test Conditions** Units Min. Typ. Max. -5 V. 0.05 - 18 GHz 0.2 0.3 Insertion Loss dB -5 V. 18 - 50 GHz 0.3 0.6 10 mA, 0.05 - 18 GHz 20 22 Isolation dB ____ 10 mA, 18 - 50 GHz 40 46 -5 V, 0.05 - 18 GHz 30 Input & Output Return Loss dB -5 V, 18 - 50 GHz 16 10% -90% RF Voltage, 10 GHz 10 Switching Speed ns

Electrical Specifications: $T_A = +25^{\circ}C$ (on wafer measurements)

1. Typical switching speed is measured from 10% to 90% of the detected RF voltage driven by a TTL compatible driver. Driver output parallel RC network uses a capacitor between 390 pF - 560 pF and a resistor between 150 - 220 Ω to achieve 10 ns rise and fall times.

Absolute Maximum Ratings @ T_A = +25°C

Parameter	Maximum Rating		
Incident CW RF Power ²	+23 dBm CW		
Breakdown Voltage	25 V		
Bias Current	±25 mA		
Junction Temperature	+150°C		
Operating Temperature	-55°C to +125°C		
Storage Temperature	-55°C to +150°C		

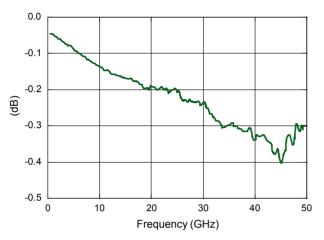
2. Maximum combined operating conditions for RF Power, DC bias, and temperature: +23 dBm CW @ 10 mA (per diode) @ +85°C.

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

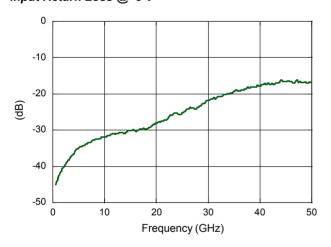
SPST Reflective AlGaAs PIN Diode Switch

Typical RF Performance (Probed on Wafer)

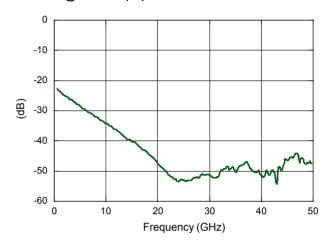
Insertion Loss @ -5 V



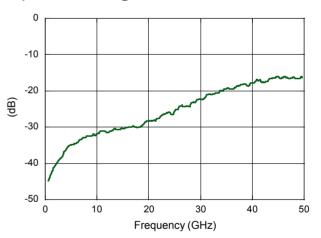
Input Return Loss @ -5 V



Isolation @ +10 mA (J2)



Output Return Loss @ -5 V



3

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



SPST Reflective AlGaAs PIN Diode Switch

Rev. V6

МАСОМ

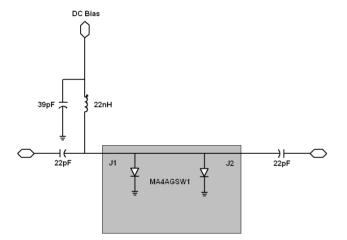
Operation of the MA4AGSW1 Switch

The application of 0 V or a negative DC voltage to either J1 or J2 provides insertion loss for the MA4AGSW1 SPST reflective switch. Isolation is achieved with 10 mA total DC current. The forward bias voltage at the diode bias node is typically 1.4 V for supply currents up to 30 mA and will not exceed 1.6 V. The backside area of the die is the RF and DC return ground plane. The bias network design should yield >30 dB RF to DC isolation.

Available for use in conjunction with MACOMs line of AlGaAs switches are two, fully integrated, broadband, monolithic, bias networks which may be used as an alternative to the suggested individual component bias network shown below. Refer to datasheets for the MA4BN1840-1 and MA4BN1840-2 for additional information.

The lowest insertion loss, P1dB, IP3, and switching speed is achieved by applying a minimum value of |-2 V| at DC bias node, which is achievable with a standard, $\pm 5 V$ TTL controlled PIN diode driver.

Schematic with 2 - 18 GHz Bias Network

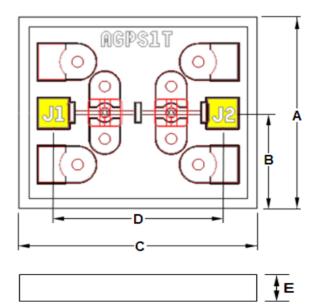


Note: The bias network can be connected to either J1 or J2

Typical Driver Connections

Control Level (DC Current)	RF Output State	
J1 or J2	J1-J2	
-5 V	Low Loss	
+10 mA	Isolation	

Chip & Bonding Pad Locations (In Yellow)



Dimensions

DIM	Mils		Millimeters	
	Min.	Max.	Min.	Max.
Α	23.5	25.5	0.597	0.648
В	11.75	12.75	0.299	0.324
С	28.50	30.50	0.724	0.775
D	20.50	21.00	0.521	0.533
E	3.50	4.50	0.089	0.114
Pads X-Y	3.50	4.50	0.089	0.114

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

4

SPST Reflective AlGaAs PIN Diode Switch



Rev. V6

Assembly Instructions

Cleanliness

These chips should be handled in a clean environment.

Static Sensitivity

These Devices are considered ESD Class 0 HBM. Proper ESD techniques should be used when handling these devices.

General Handling

The protective polymer coating on the active areas of the die provides scratch and impact protection, particularly for the metal air bridge, which contacts the diode's anode. Die should primarily be handled with vacuum pickups, or alternatively with plastic tweezers.

Assembly Technique

The MA4AGSW1, AlGaAs switch is designed to be mounted with electrically conductive silver epoxy or with a lower temperature solder perform, which does not have a rich tin content.

Solder Die Attach

All die attach and bonding methods should be compatible with gold metal. Solder which does not scavenge gold, such as 80/20, Au/Sn or Indalloy #2 is recommended. Do not expose die to temperatures greater than 300°C for more than 10 seconds.

Electrical Conductive Epoxy Die Attach

Use a controlled thickness of approximately 2 mils for best electrical conductivity and lowest thermal resistance. Cure epoxy per manufacturer's schedule. Typically 150°C for 1 hour.

Ribbon / Wire Bonding

Thermo-compression wedge or ball bonding may be used to attach ribbons or wire to the gold bonding pads. A $1/4 \times 3$ mil gold ribbon is recommended on all RF ports and should be kept as short as possible for the lowest inductance and best microwave performance. For more detailed handling and assembly instructions, see Application Note M541.

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.

SPST Reflective AIGaAs PIN Diode Switch



Rev. V6

MACOM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with MACOM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.

⁶

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.